OV13860 13MP product brief





Industry's Best 13-Megapixel Image Sensor with Large 1.3-Micron Pixels and Stacked Die Technology for Flagship Smartphones

The PureCel-S[™] OV13860 is a unique 13-megapixel sensor with large 1.3-micron pixels – 35 percent larger than those of traditional 13-megapixel sensors. Despite its 1/2.6-inch sensor size, the OV13860 uses a high chief ray angle (CRA) to enable a camera module z-height of 5.5 mm, suitable for today's slim smartphones.

The OV13860 is the first of OmniVision's family of PureCel[™] backside-illuminated image sensors to leverage the company's stacked die technology, which separates the imaging array from the image sensor processing pipeline into a stacked die structure. This allows for additional functionality to be implemented on the sensor while providing for much smaller die sizes compared to non-stacked sensors, thus enabling smaller module sizes for larger optical format sensors.

Among the OV13860's advanced features is autofocus contrast calculation at an extremely fast 120 frames per second (fps) while imaging at full-resolution to enable a fast autofocus camera system.

When paired with a high-speed actuator, the OV13860 can provide instant autofocus by delivering contrast statistics at up to four times faster than traditional single frame-based contrast calculations. The OV13860 also supports alternate row, dualexposure high dynamic range (HDR) timing mode for delivering HDR video in challenging lighting scenes.

The OV13860's large 1.3-micron pixel enables dramatically improved high and low light performance as a result of higher sensitivity, signal-to-noise ratio, and full-well capacity when compared to products of similar or higher resolution with 1.12 μm pixels. The OV13860 can capture full-resolution 13-megapixel still images at 30 fps or record ultra-high resolution 4K2K video at 30 fps, 1080p full HD at 60 fps, or 720p HD at 120 fps. Each video output format includes additional pixels to support electronic image stabilization (EIS).

Find out more at www.ovt.com.





Applications

- Smartphones
- Tablets

PC Multimedia

Product Features

- 1.3 µm x 1.3 µm pixel
- optical size of 1/2.6"
- 13MP at 30 fps
- automatic black level calibration (ABLC)
- programmable controls for frame rate, mirror and flip, cropping, and windowing
- supports output formats: 16/14/12/10-bit HDR RAW or 10-bit RAW RGB
- supports horizontal and vertical subsampling
- supports 2x2 binning, re-sampling filter
- standard serial SCCB interface
- built-in temperature sensor

- up to 4-lane MIPI TX interface with speed up to 1.5 Gbps/lane
- 20kbits (or 2560 bytes) of OTP memory - 11kbits (or 1375 bytes) reserved for customer use
- alternate row HDR
- support for high speed auto focus at 120 Hz
- two on-chip phase lock loops (PLLs)
- programmable I/O drive capability
- image quality control: defect pixel correction (DPC), denoise, lens shading correction
- suitable for 9.5 x 9.5 x -5.5 mm module size

Ordering Information

- OV13860-G05A-Z
- (color, chip probing, 150 µm backgrinding, reconstructed wafer with good die)

Product Specifications

- active array size: 4224 x 3120
- power supply: - core: 1.2V - apples: 2.8V
- analog: 2.8V - I/O: 1.8V
- power requirements:
 active: TBD
 standby: TBD
 - XSHUTDOWN: TBD
- temperature range:
 operating: -30°C to +85°C junction temperature
 stable image: 0°C to +60°C junction temperature
- output formats: 10-bit RGB RAW, 16/14/12/10-bit HDR RAW

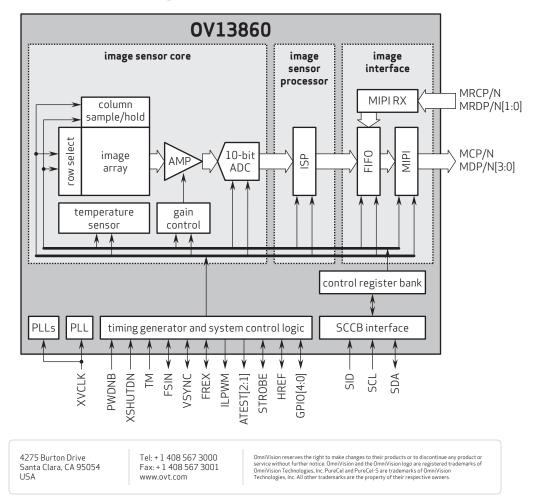
■ lens size: 1/2.6"

lens chief ray angle: 33.4° non-linear

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- input clock frequency: 6 27 MHz
- maximum image transfer rate:
 4224x3120: 30 fps
 2112x1560: 60 fps
- scan mode: progressive
- pixel size: 1.3 µm x 1.3 µm
- **image area:** 5554.1 μm x 4113.4 μm
- die dimensions:
 COB: 6244.2 μm x 4795.2 μm
 RW: 6294.2 μm x 4845.2 μm

Functional Block Diagram





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